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U.S. Department of Commerce Patent and Trademark Office

B/O FORM PTO-1595 (Rev. 4/00)

To the Commissioner for Patents. Please record the attached original documents or copies thereof.

06/22/11

<p>1. Name of Conveying Party(ies):</p> <p style="text-align: center;">Jiunn-Yih CHYAN Jer-Liang YEH Wen-Ching HSU Suz-Hua HO</p>	<p>2. Name and Address of Receiving Party(ies):</p> <p>Name: Sino-American Silicon Products Inc.</p> <p>Street Address: No. 8, Industrial East Road 2, Science-Based Industrial Park</p> <p>City, State, Zip: Hsinchu, Taiwan R.O.C.</p> <p><input type="checkbox"/> Additional name(s) and address(es) attached.</p>
<p>3. Nature of Conveyance:</p> <p><input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger</p> <p><input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name</p> <p><input type="checkbox"/> Other:</p> <p>Execution Date: June 2, 2011; June 3, 2011; June 8, 2011; June 8, 2011</p>	

<p>4. (A) Patent Application Number(s):</p> <p style="text-align: right;">June 2, 2011; June 3, 2011; June 8, 2011;</p> <p>If this document is being filed together with a new application, the execution date of the application is: June 8, 2011</p>	<p>4. (B) Patent Number(s):</p> <p style="text-align: center;"><input type="checkbox"/> Additional Numbers Attached.</p>
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Title: EPITAXIAL SUBSTRATE HAVING NANO-RUGGED SURFACE, SEMICONDUCTOR LIGHT-EMITTING DEVICE USING SUCH EPITAXIAL SUBSTRATE AND FABRICATION THEREOF

Attorney Docket No.: CHYA3001/EM

<p>5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:</p> <p>Name: Eugene Mar</p> <p>23364 CUSTOMER NUMBER</p> <p>Bacon & Thomas, PLLC 625 Slaters Lane Fourth Floor Alexandria, VA 22314</p>	<table border="1"> <tr> <td>Total Number of Applications and Patents Involved:</td> <td style="text-align: center;">1</td> </tr> <tr> <td>7. Total Fee: (37 CFR 3.41)</td> <td style="text-align: center;">\$40.00</td> </tr> <tr> <td colspan="2"> <input checked="" type="checkbox"/> Enclosed <input type="checkbox"/> Authorized to be charged to deposit account </td> </tr> <tr> <td>8. Deposit Account Number:</td> <td style="text-align: center;">02-0200</td> </tr> </table>	Total Number of Applications and Patents Involved:	1	7. Total Fee: (37 CFR 3.41)	\$40.00	<input checked="" type="checkbox"/> Enclosed <input type="checkbox"/> Authorized to be charged to deposit account		8. Deposit Account Number:	02-0200
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8. Deposit Account Number:	02-0200								

9. Statement and Signature:

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

Eugene Mar		June 22, 2011
Name of Person Signing	Signature	Date

Total number of pages including cover sheet, attachments and document: 3

EM/bh

06/23/2011 SHOHAMME 00000003 13067710
04 FC:0021
PATENT 40.00 OP
REEL: 026603 FRAME: 0798

ATTORNEY/DOCKET NO:

ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: **EPITAXIAL SUBSTRATE HAVING NANO-RUGGED SURFACE, SEMICONDUCTOR LIGHT-EMITTING DEVICE USING SUCH EPITAXIAL SUBSTRATE AND FABRICATION THEREOF**

the specification of which (check one):

<input checked="" type="checkbox"/>	is executed on even date herewith.	
<input type="checkbox"/>	was filed on (day-month-year)	as U.S. Application Number
<input type="checkbox"/>	was filed on (day-month-year)	as Taiwan Application Number
<input type="checkbox"/>	was executed on the following date(s) (day-month-year)	

WHEREAS, Sino-American Silicon Products Inc.

having a postal address of No. 8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

ASSIGNOR authorizes any member of the firm of Bacon & Thomas, PLLC to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office.


Full Name of First or Sole Inventor JIUNN-YIH, CHYAN	Post Office Address c/o No. 8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
Citizenship Taiwan, R.O.C.	Residence (city, and either state or foreign country, MPEP §605.02) c/o No. 8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
Date 6/02/2011	Signature <i>J. Y. Chyan</i>

See following page(s) for additional joint inventors.

(06Nov2001)

ATTORNEY/DOCKET NO:

SUPPLEMENTAL PAGE FOR AN
ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

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Date 6/03/2011	Signature 

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Date June, 08/2011	Signature Wen - ching, Hsu

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Date 6/08/2011	Signature SUZ-HUA, HO

Full Name of Joint Inventor	Post Office Address
Citizenship	Residence (city, and either state or foreign country, MPEP §605.02)
Date	Signature

See following page(s) for additional joint inventors.

(05Nov2001)